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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/518,945	07/13/2005	Yoshihiro Ito	36856.1310	4943
54066	7590	06/14/2007		
MURATA MANUFACTURING COMPANY, LTD. C/O KEATING & BENNETT, LLP 8180 GREENSBORO DRIVE SUITE 850 MCLEAN, VA 22102			EXAMINER	
			HARRISON, MONICA D	
			ART UNIT	PAPER NUMBER
			2813	
			NOTIFICATION DATE	DELIVERY MODE
			06/14/2007	ELECTRONIC

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

JKEATING@KBIPLAW.COM
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Office Action Summary	Application No.	Applicant(s)	
	10/518,945	ITO ET AL.	
	Examiner	Art Unit	
	Monica D. Harrison	2813	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 13 July 2005.
 2a) This action is FINAL. 2b) This action is non-final.
 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 10-28 is/are pending in the application.
 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
 5) Claim(s) _____ is/are allowed.
 6) Claim(s) 10-28 is/are rejected.
 7) Claim(s) _____ is/are objected to.
 8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.
 10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
 Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
 a) All b) Some * c) None of:
 1. Certified copies of the priority documents have been received.
 2. Certified copies of the priority documents have been received in Application No. _____.
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)
 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
 3) Information Disclosure Statement(s) (PTO/SB/08)
 Paper No(s)/Mail Date 3/20/07

4) Interview Summary (PTO-413)
 Paper No(s)/Mail Date. _____.
 5) Notice of Informal Patent Application
 6) Other: _____

DETAILED ACTION

Priority

1. Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 10, 11, 20 and 21 are rejected under 35 U.S.C. 102(e) as being anticipated by Wang et al (6,863,943 B2).

2. Regarding claim 10, Wang et al discloses a semiconductor device comprising: a single crystal substrate primarily including zinc oxide and having a zinc-polar surface and an oxygen-polar surface; and at least one layer of thin film primarily including zinc oxide disposed on the zinc-polar surface (column 5, lines 66-67 thru column 6, lines 1-26).

3. Regarding claim 11, Wang et al discloses wherein the at least one layer of thin film has zinc-polarity (column 6, lines 19-26).

4. Regarding claim 20, Wang et al discloses a method for manufacturing a semiconductor device, comprising the steps of: determining whether a surface of a single crystal substrate primarily including zinc oxide is a zinc-polar surface or an oxygen-polar surface; an

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forming at least one layer of thin film primarily including zinc oxide on the zinc-polar surface (column 5, lines 64-67 thru column 6, lines 1-26).

5. Regarding claim 21, Wang et al discloses wherein the thin film has zinc-polarity (column 6, lines 19-26).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 12-19 and 22-28 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wang et al (6,863,943 B2) in view of Tanabe et al (6,735,230 B1).

6. Wang et al discloses all above claimed subject matter except wherein the at least one layer of thin film includes a multilayer film and the multilayer film defines a light-emitting layer (claims 12 and 25), wherein the at least one layer of thin film includes a multilayer film and the multilayer film defines a switching portion (claims 13 and 26), wherein the multilayer film includes an n-type contact layer, an n-type clad layer, an active layer, a p-type clad layer and a p-type contact layer (claims 14 and 27), further comprising a transparent electrode disposed on the multilayer film (claim 15), wherein the transparent electrode is made of Indium Tin Oxide (claim 16), wherein the multilayer film includes an n-type contact layer, an n-type clad layer, an n-type light guide layer, an active layer, a p-type light guide layer, a p-type clad layer, a current limiting layer, and a p-type contact layer (claims 17 and 28), further comprising a p-side electrode disposed on the multilayer film (claim 18), wherein the p-side electrode includes a Ni film, an

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Al film, and a Au film (claim 19), providing a sputtering apparatus provided with a plasma generation chamber and a separate film formation chamber; and performing sputtering treatment using the sputtering apparatus so as to form the thin film (claim 22), wherein the sputtering treatment is performed by a method selected from the group consisting of an electron cyclotron resonance plasma sputtering method, an inductively coupled plasma sputtering method, a sputtering method, an ion beam sputtering method, method helicon wave excited plasma and a cluster beam sputtering (claim 23), wherein the thin film is formed by a method selected from the group consisting of a molecular-beam epitaxy method, a metal organic chemical vapor deposition method, a laser molecular-beam epitaxy method, and a laser abrasion method (claim 24).

Tanabe et al discloses wherein the at least one layer of thin film includes a multilayer film and the multilayer film defines a light-emitting layer (Figure 1, reference 11), wherein the at least one layer of thin film includes a multilayer film and the multilayer film defines a switching portion (Figure 1, reference 11), wherein the multilayer film includes an n-type contact layer (Figure 1, reference 3), an n-type clad layer (Figure 1, reference 4), an active layer (Figure 1, reference 5), a p-type clad layer (Figure 1, reference 6) and a p-type contact layer (Figure 1, reference 7), further comprising a transparent electrode disposed on the multilayer film (column 15, lines 26-46), wherein the transparent electrode is made of Indium Tin Oxide (column 15, lines 26-46), wherein the multilayer film includes an n-type contact layer (Figure 1, reference 3), an n-type clad layer (Figure 1, reference 4), an n-type light guide layer (Figure 1, reference 14), an active layer (Figure 1, reference 5), a p-type light guide layer (Figure 1, reference 16), a p-type clad layer (Figure 1, reference 6), a current limiting layer (Figure 16, reference 17), and a p-

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type contact layer (Figure 1, reference 7), further comprising a p-side electrode disposed on the multilayer film (Figure 1, reference 10), wherein the p-side electrode includes a Ni film, an Al film, and a Au film (column 13, lines 20-30), providing a sputtering apparatus provided with a plasma generation chamber and a separate film formation chamber; and performing sputtering treatment using the sputtering apparatus so as to form the thin film (column 29, lines 7-25), wherein the sputtering treatment is performed by a method selected from the group consisting of an electron cyclotron resonance plasma sputtering method, an inductively coupled plasma sputtering method, a sputtering method, an ion beam sputtering method, method helicon wave excited plasma and a cluster beam sputtering (column 29, lines 7-25), wherein the thin film is formed by a method selected from the group consisting of a molecular-beam epitaxy method, a metal organic chemical vapor deposition method, a laser molecular-beam epitaxy method, and a laser abrasion method (column 33, lines 13-15).

It would have been obvious, at the time the invention was made, for one having ordinary skill in the art, to modify Wang et al with the teachings of Tanabe et al, for the purpose of making a light emitting device (LED).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Monica D. Harrison whose telephone number is 571-272-1959. The examiner can normally be reached on M-F 7:00am-3:30pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead Jr. can be reached on 571-272-1702. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Monica D. Harrison
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mdh
June 6, 2006



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